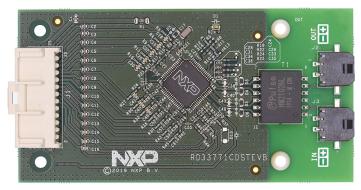
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RD33771CDSTEVB featuring the MC33771C battery cell controller IC

Rev. 1.0 — 14 January 2020

User manual



aaa-036295

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1 Getting started

The NXP analog product development boards provide an easy-to-use platform for evaluating NXP products. These development boards support a range of analog, mixed-signal, and power solutions. These boards incorporate monolithic integrated circuits and system-in-package devices that use proven high-volume technology. NXP products offer longer battery life, a smaller form factor, reduced component counts, lower cost, and improved performance in powering state-of-the-art systems.

The tool summary page for RD33771CDSTEVB is at nxp.com/RD33771CDSTEVB. The overview tab on this page provides an overview of the device, a list of device features, a description of the kit contents, links to supported devices and a **Get Started** section.

The **Get Started** section provides information applicable to using the RD33771CDSTEVB.

- 1. Go to nxp.com/RD33771CDSTEVB.
- On the Overview tab, locate the Jump To navigation feature on the left side of the window.
- 3. Select the Get Started link.
- 4. Review each entry in the Get Started section.
- 5. Download an entry by clicking on the linked title.

After reviewing the **Overview** tab, visit the other related tabs for additional information:

- **Documentation**: Download current documentation.
- Software & Tools: Download current hardware and software tools.
- Buy/Parametrics: Purchase the product and view the product parametrics.

After downloading files, review each file, including the user guide, which includes setup instructions. If applicable, the Bill of Materials (BOM), suporting schematics, and layout are available via NXP DocStore. [5]

1.1 Kit contents/packing list

The kit contents include:

- · Assembled and tested evaluation board/module in anti-static bag
- · Cell terminal cable
- · TPL cable
- · Quick-start guide

1.2 Required equipment

To use this kit, you need:

• A 7- to 14-cell battery pack or a battery pack emulator, such as BATT-14CEMULATOR

2 Getting to know the hardware

2.1 Board overview

The RD33771CDSTEVB serves as a hardware evaluation tool in support of NXP's MC33771C device. The MC33771C is a battery cell controller that monitors up to 14 lithium-ion battery cells. It is designed for use in both automotive and industrial

UM11343

RD33771CDSTEVB featuring the MC33771C battery cell controller IC

applications. The device performs ADC conversion on the differential cell voltages and currents. It is also capable of battery charge coulomb counting and battery temperature measurements. The RD33771CDSTEVB is an ideal platform for rapid prototyping of MC33771C-based applications that involve current, voltage, and temperature sensing.

The RD33771CDSTEVB includes a transformer enabling communication in a high-speed isolated communication network. The information is digitally transmitted to a microcontroller for processing. The evaluation board can be used in conjunction with a transceiver physical layer transformer driver (MC33664) to convert MCU SPI data bits to pulse bit information for the MC33771C and vice versa.

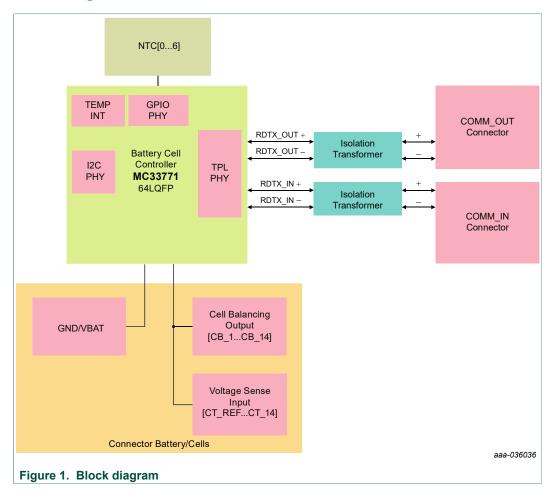
2.2 Board features

This RD33771CDSTEVB's main features are as follows:

- · Daisy chain device connection
- · LED indicator for operation mode
- Cell-balancing resistors
- · Transformer isolation
- · Cell sense input with RC filter
- GPIO: digital I/O, wake-up inputs, convert trigger inputs, ratiometric analog inputs, analog inputs with absolute measurements

RD33771CDSTEVB featuring the MC33771C battery cell controller IC

2.3 Block diagram



2.4 Device features

The MC33771C is a battery cell controller IC designed to monitor battery characteristics, such as voltage, current and temperature. The MC33771C contains all the circuit blocks necessary to perform synchronous battery cell voltage/current measurement, coulomb counting, cell temperature measurement and integrated cell balancing. The device supports the following functions:

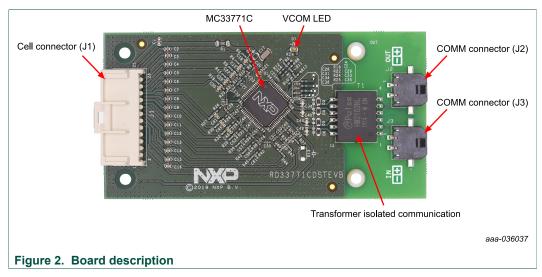
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Table 1. MC33771C device features

Device	Description	Features
MC33771C	Battery cell controller	 9.6 V ≤ V_{PWR} ≤ 61.6 V operation, 75 V transient 7 to 14 cells management Isolated 2.0 Mbps differential communication or 4.0 Mbps SPI Addressable on initialization Bidirectional transceiver to support up to 63 nodes in daisy chain 0.8 mV maximum total voltage measurement error Synchronized cell voltage/current measurement with coulomb count Averaging of cell voltage measurements Total stack voltage measurement Seven GPIO/temperature sensor inputs 5.0 V at 5.0 mA reference supply output Automatic over/undervoltage and temperature detection routable to fault pin Integrated sleep mode over/undervoltage and temperature monitoring Onboard 300 mA passive cell balancing with diagnostics Hot plug capable Detection of internal and external faults, as open lines, shorts, and leakages Designed to support ISO 26262, up to ASIL D safety system Qualified in compliance with AECQ-100

2.5 Board description

The RD33771CDSTEVB allows the user to exercise all the functions of the MC33771C battery controller cell.



2.6 VCOM LED

The VCOM LED is located on the board as shown in Figure 2.

The VCOM LED indicates when the device is in normal mode. Upon reset, the MC33771C enters into normal mode (VCOM turns on). If there is no activity on the bus after a timeout period of 60 seconds, the device enters low-power idle mode (VCOM turns off). Once the device is initialized, if no communication occurs on the TPL bus

UM11343

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after one second, the device resets and the LED turns off (VCOM off). Depending on the device settings, the VCOM LED may flash 0.1...8 seconds during cyclic acquisition.

2.7 Connectors

<u>Figure 2</u> shows the location of connectors on the board. The following tables list the pinouts for each connector.

Table 2. Cell connector (J1)

Pin	Connection	Description
1	GND	NTC connection (-)
2	NTC3	NTC connection (+)
3	GND	NTC connection (-)
4	NTC2	NTC connection (+)
5	GND	NTC connection (-)
6	NTC1	NTC connection (+)
7	GND	NTC connection (-)
8	NTC0	NTC connection (+)
9	GND	negative battery
10	GND	negative battery
11	CELL_1	Battery cell1P connection
12	CELL_REF	Battery cell1M connection
13	CELL_3	Battery cell3P connection
14	CELL_2	Battery cell2P connection
15	CELL_5	Battery cell5P connection
16	CELL_4	Battery cell4P connection
17	CELL_7	Battery cell7P connection
18	CELL_6	Battery cell6P connection
19	CELL_9	Battery cell9P connection
20	CELL_8	Battery cell8P connection
21	CELL_11	Battery cell11P connection
22	CELL_10	Battery cell10P connection
23	CELL_13	Battery cell13P connection
24	CELL_12	Battery cell12P connection
25	VBAT	positive battery
26	CELL_14	Battery cell14P connection

Table 3. COMM connector (J2)

Pin#	Name	Description
1	OUT+	Receive/transmit output positive

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Pin#	Name	Description
2	OUT-	Receive/transmit output negative

Table 4. COMM connector (J3)

Pin#	Name	Description
1	IN+	Receive/transmit input positive
2	IN-	Receive/transmit input negative

2.8 Temperature measurement

The RD33771CDSTEVB offers seven GPIOs [GPIO_0...GPIO_6] for measuring external temperature with on-board or off-board NTCs. Four off-board NTC connections are available on J1 connector.

2.9 Cell terminal voltage measurement

The differential measurement of each cell terminal input is designed to function in conjunction with an external anti-aliasing filter.

2.10 Bus terminal communication

The transformers isolate communication between the MC33771C and the pack controller and between each MC33771C. They are protected against ESD. There are significant advantages to using transformers for isolation and communication:

- · High degree of voltage isolation
- · Communication rates of 2.0 MHz with very low radiated emissions
- · Ability to force the secondary signals to be true differential reducing radiated emissions
- · Ability to loop the network back to the pack controller

Detailed schematic, component selection, and layout recommendations can be obtained from the NXP DocStore (NDA required). [5]

3 Accessory transceiver board

The RD33771CDSTEVB kit is designed for use with the FRDMDUAL33664EVB in high-voltage isolated applications that provide a SPI-to-high-speed isolated communication interface. The FRDMDUAL33664EVB includes two MC33664 isolated network high-speed transceivers allowing loopback connection. MCU SPI data bits are directly converted to pulse bit information.

RD33771CDSTEVB featuring the MC33771C battery cell controller IC

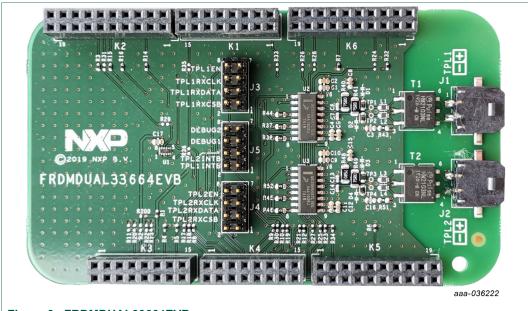


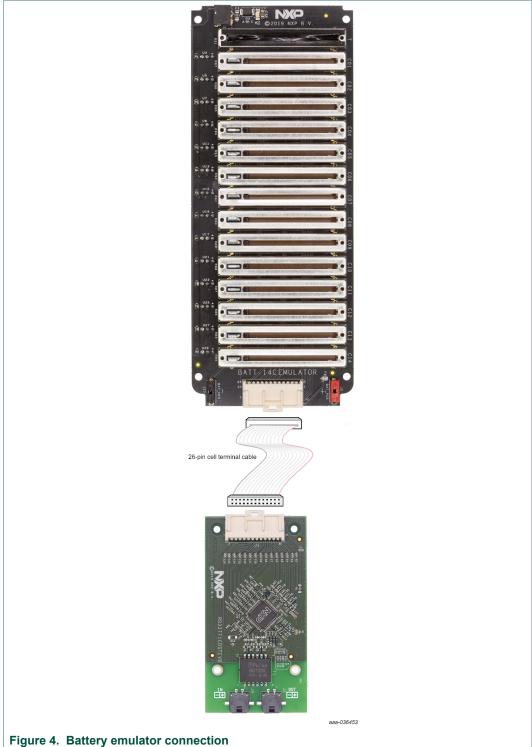
Figure 3. FRDMDUAL33664EVB

4 Configuring the hardware

4.1 Battery emulator connection

A minimum of 7 cells and a maximum of 14 cells can be monitored. NXP provides a 14-cell battery emulator board, BATT-14CEMULATOR. This board provides an intuitive way to change the voltage across any of the 14 cells of an emulated battery pack and four voltage outputs to emulate four external NTC. The emulator board can be connected to the RD33771CDSTEVB connector J1 using the provided supply cable. See Figure 4.

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4.2 TPL communication connection

In a high-voltage Isolated application with a daisy chain configuration, up to 63 RD33771CDSTEVB boards may be connected.

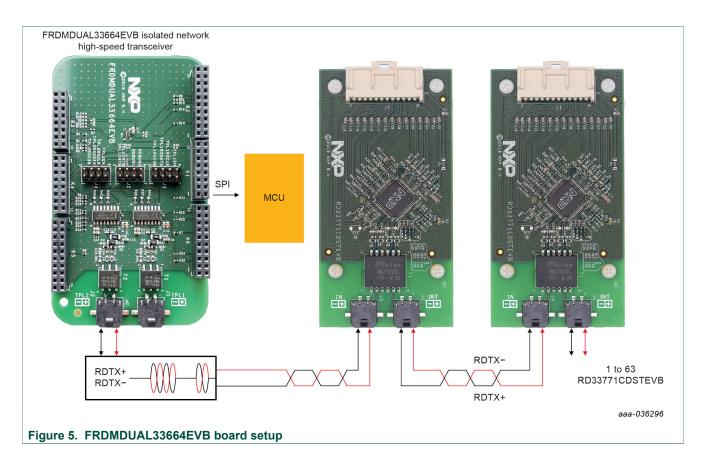
The TPL connections use the COMM connectors (J2, J3).

UM11343

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5 Available accessories

Note: NXP does not assume liability, endorse, or warrant components from external manufacturers are referenced in circuit drawings or tables. While NXP offers component recommendations in this configuration, it is the customer's responsibility to validate their application.

Table 5. Bill of materials

Part number	Description	
BATT-14CEMULATOR	14-cell slider battery pack emulator kit with shunt for current sense	
FRDMDUAL33664EVB	EVB for MC33664ATL Isolated Network High-Speed Transceiver	

6 References

- [1] Board summary page nxp.com/RD33771CDSTEVB
- [2] Product summary page nxp.com/BATTERY-CELL-CONTROLLERS
- [3] Tool summary page nxp.com/FRDMDUAL33664EVB
- [4] Tool summary page for battery emulators nxp.com/BATT-14CEMULATOR
- [5] NXP DocStore docstore.nxp.com

RD33771CDSTEVB featuring the MC33771C battery cell controller IC

7 Revision history

Table 6. Revision history

Rev	Date	Description
v.1.0	20200114	Initial release

RD33771CDSTEVB featuring the MC33771C battery cell controller IC

8 Legal information

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RD33771CDSTEVB featuring the MC33771C battery cell controller IC

Tables

Tab. 2.	MC33771C device features 5 Cell connector (J1) 6 COMM connector (J2) 6	Tab. 5.	Bill of materials	10
Figur	es			
Fig. 1. Fig. 2. Fig. 3.	Block diagram 4 Board description 5 FRDMDUAL33664EVB 8		Battery emulator connectionFRDMDUAL33664EVB board setup	

RD33771CDSTEVB featuring the MC33771C battery cell controller IC

Contents

1	Getting started	2
1.1	Kit contents/packing list	2
1.2	Required equipment	2
2	Getting to know the hardware	
2.1	Board overview	
2.2	Board features	3
2.3	Block diagram	
2.4	Device features	4
2.5	Board description	5
2.6	VCOM LED	
2.7	Connectors	6
2.8	Temperature measurement	7
2.9	Cell terminal voltage measurement	7
2.10	Bus terminal communication	
3	Accessory transceiver board	7
4	Configuring the hardware	8
4.1	Battery emulator connection	8
4.2	TPL communication connection	9
5	Available accessories	10
6	References	10
7	Revision history	11
8	Legal information	12

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